LF2802A

RF Power MOSFET Transistor
2 W, 500 - 1000 MHz, 28 V

Rev. V1

Features

- N-Channel enhancement mode device
- DMOS structure
- Lower capacitances for broadband operation
- Common source configuration
- Lower noise floor
- Applications
  - Broadband linear operation
  - 500 MHz to 1400 MHz
- RoHS Compliant

Absolute Maximum Ratings @ 25°C

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	65	V
Gate-Source Voltage	V_{GS}	20	V
Drain-Source Current	I_{DS}	0.7	A
Power Dissipation	P_D	8	W
Junction Temperature	T_J	200	°C
Storage Temperature	T_{STG}	-55 to +150	°C
Thermal Resistance	θ_{JC}	21.8	°C/W

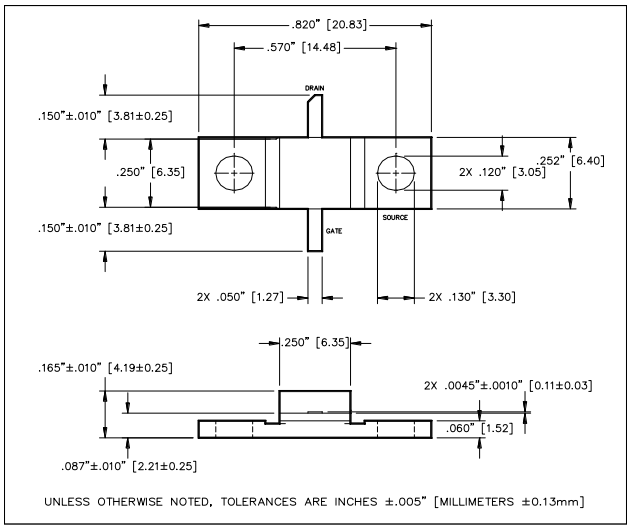
Typical Device Impedance

F (MHz)	Z_{IN} (Ω)	Z_{LOAD} (Ω)
500	10.0 - j41.5	40.0 +j53.0
1000	4.2 - j12.0	11.85 + j33.0
1400	3.5 - j1.0	7.5 + j23.3
V_{DD} = 28V, I_{DQ} = 25mA, P_{OUT} = 2.0 W		

Z_{IN} is the series equivalent input impedance of the device from gate to source.

Z_{LOAD} is the optimum series equivalent load impedance as measured from drain to ground.

Package Outline



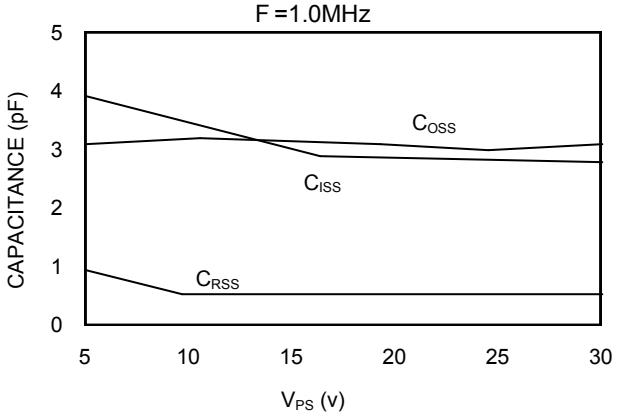
LETTER DIM.	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	20.70	20.96	.815	.825
B	14.35	14.61	.565	.575
C	13.72	14.22	.540	.560
D	6.27	6.53	.247	.257
E	6.22	6.48	.245	.255
F	6.22	6.48	.245	.255
G	1.14	1.40	.045	.055
H	2.92	3.18	.115	.125
J	1.40	1.65	.055	.065
K	1.96	2.46	.077	.097
L	3.61	4.37	.142	.172
M	.08	.15	.003	.006

Electrical Characteristics @ 25°C

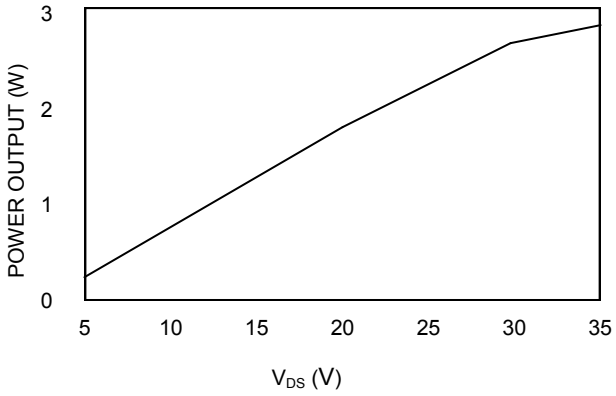
Parameter	Symbol	Min	Max	Units	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	65	-	V	V_{GS} = 0.0 V , I_{DS} = 1.0 mA
Drain-Source Leakage Current	I_{DSS}	-	0.5	mA	V_{GS} = 28.0 V , V_{GS} = 0.0 V
Gate-Source Leakage Current	I_{GSS}	-	0.5	µA	V_{GS} = 20.0 V , V_{DS} = 0.0 V
Gate Threshold Voltage	$V_{GS(TH)}$	2.0	6.0	V	V_{DS} = 10.0 V , I_{DS} = 5.0 mA
Forward Transconductance	G_M	40	-	mS	V_{DS} = 28.0 V , I_{DS} = 50.0 mA , Δ V_{GS} = 1.0V, 80 µs Pulse
Input Capacitance	C_{ISS}	-	3.5	pF	V_{DS} = 28.0 V , F = 1.0 MHz
Output Capacitance	C_{OSS}	-	3.75	pF	V_{DS} = 28.0 V , F = 1.0 MHz
Reverse Capacitance	C_{RSS}	-	1.2	pF	V_{DS} = 28.0 V , F = 1.0 MHz
Power Gain	G_P	10	-	dB	V_{DD} = 28.0 V, I_{DQ} = 25 mA, P_{OUT} = 2.0 W F =1.0 GHz
Drain Efficiency	η_D	40	-	%	V_{DD} = 28.0 V, I_{DQ} = 25 mA, P_{OUT} = 2.0 W F =1.0 GHz
Load Mismatch Tolerance	VSWR-T	-	20:1	-	V_{DD} = 28.0 V, I_{DQ} = 25 mA, P_{OUT} = 2.0 W F =1.0 GHz

Typical Broadband Performance Curves

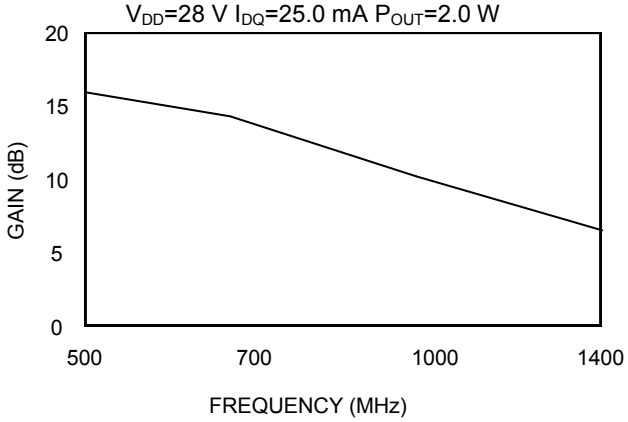
CAPACITANCES vs VOLTAGE
F =1.0MHz



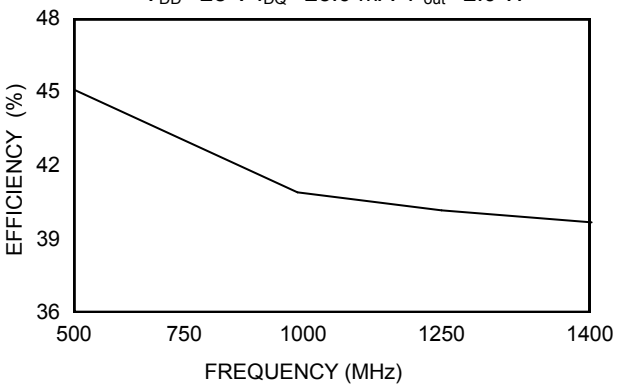
POWER OUTPUT vs VOLTAGE
F =1.0GHz P_{IN}=2.0 W I_{DQ}=25 mA



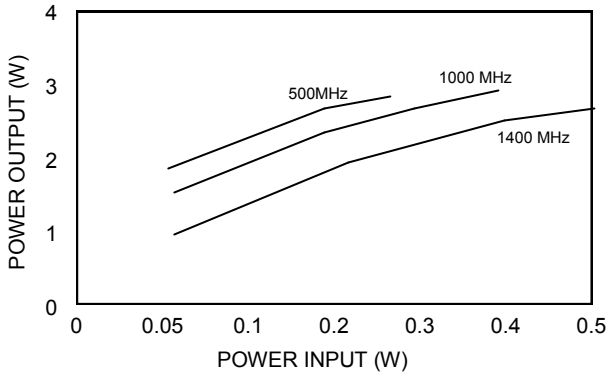
GAIN vs FREQUENCY
V_{DD}=28 V I_{DQ}=25.0 mA P_{OUT}=2.0 W



EFFICIENCY vs FREQUENCY
V_{DD} =28 V I_{DQ} =25.0 mA P_{out} =2.0 W



POWER OUTPUT vs POWER INPUT
V_{DD} =28 V I_{DQ} =25.0 mA



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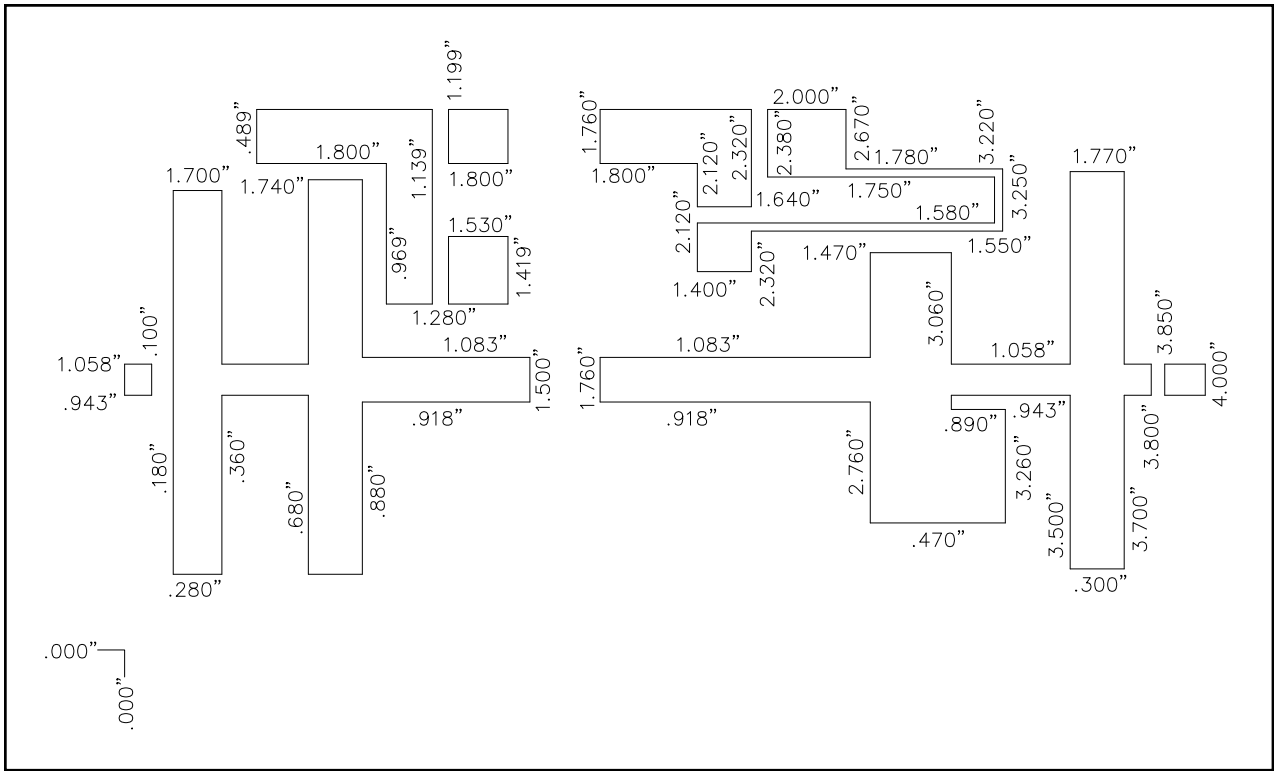
TEST FIXTURE CIRCUIT DIMENSIONS



TEST FIXTURE ASSEMBLY